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# EMC1182 Temperature Sensor Evaluation Board User's Guide

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Signed for and on behalf of Microchip Technology Inc. at Chandler, Arizona, USA

rek Carlson

Derek Carlson VP Development Tools

<u>16-July-2013</u> Date

NOTES:



# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD USER'S GUIDE

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# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD

### Preface

### NOTICE TO CUSTOMERS

All documentation becomes dated, and this manual is no exception. Microchip tools and documentation are constantly evolving to meet customer needs, so some actual dialogs and/or tool descriptions may differ from those in this document. Please refer to our web site (www.microchip.com) to obtain the latest documentation available.

Documents are identified with a "DS" number. This number is located on the bottom of each page, in front of the page number. The numbering convention for the DS number is "DSXXXXA", where "XXXXX" is the document number and "A" is the revision level of the document.

For the most up-to-date information on development tools, see the MPLAB<sup>®</sup> IDE online help. Select the Help menu, and then Topics to open a list of available online help files.

### INTRODUCTION

This chapter contains general information that will be useful to know before using the EMC1182 Temperature Sensor Evaluation Board. Items discussed in this chapter include:

- Document Layout
- · Conventions Used in this Guide
- Recommended Reading
- · The Microchip Web Site
- Customer Support
- Document Revision History

### DOCUMENT LAYOUT

This document describes how to use the EMC1182 Temperature Sensor Evaluation Board as a development tool to emulate and debug firmware on a target board. The manual layout is as follows:

- Chapter 1. "Product Overview" Important information about the EMC1182 Temperature Sensor Evaluation Board.
- Chapter 2. "Installation and Operation" Includes instructions on installing and starting the SMSC<sup>™</sup> Chip Manager application.
- **Chapter 3. "Hardware Description"** Shows hardware details of the EMC1182 Temperature Sensor Evaluation Board.
- Chapter 4. "Software Description" Describes the main operations in the SMSC Chip Manager software.
- Appendix A. "Schematic and Layouts" Shows the schematic and layout diagrams for the EMC1182 Temperature Sensor Evaluation Board.
- Appendix B. "Bill of Materials (BOM)" Lists the parts used to build the EMC1182 Temperature Sensor Evaluation Board.

### **CONVENTIONS USED IN THIS GUIDE**

This manual uses the following documentation conventions:

#### **DOCUMENTATION CONVENTIONS**

Description	Represents	Examples		
Arial font:				
Italic characters	Referenced books	MPLAB <sup>®</sup> IDE User's Guide		
	Emphasized text	is the only compiler		
Initial caps	A window	the Output window		
	A dialog	the Settings dialog		
	A menu selection	select Enable Programmer		
Quotes	A field name in a window or dialog	"Save project before build"		
Underlined, italic text with right angle bracket	A menu path	<u>File&gt;Save</u>		
Bold characters	A dialog button	Click OK		
	A tab	Click the <b>Power</b> tab		
N'Rnnnn	A number in verilog format, where N is the total number of digits, R is the radix and n is a digit.	4'b0010, 2'hF1		
Text in angle brackets < >	A key on the keyboard	Press <enter>, <f1></f1></enter>		
Courier New font:				
Plain Courier New	Sample source code	#define START		
	Filenames	autoexec.bat		
	File paths	c:\mcc18\h		
	Keywords	_asm, _endasm, static		
	Command-line options	-Opa+, -Opa-		
	Bit values	0, 1		
	Constants	OxFF, `A'		
Italic Courier New	A variable argument	<i>file.</i> o, where <i>file</i> can be any valid filename		
Square brackets [ ]	Optional arguments	mcc18 [options] <i>file</i> [options]		
Curly brackets and pipe character: {   }	Choice of mutually exclusive arguments; an OR selection	errorlevel {0 1}		
Ellipses	Replaces repeated text	<pre>var_name [, var_name]</pre>		
	Represents code supplied by user	<pre>void main (void) { }</pre>		

### **RECOMMENDED READING**

This user's guide describes how to use the EMC1182 Temperature Sensor Evaluation Board. Another useful document is listed below. The following Microchip document is available and recommended as a supplemental reference resource.

 EMC1182 Data Sheet – "Dual Channel 1.8V SMBus/l<sup>2</sup>C Temperature Sensor with Resistance Error Correction, Beta Compensation" (EMC1182 DS Rev. 1.0)

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- General Technical Support Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip consultant program member listing
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- Technical Support

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Technical support is available through the web site at: http://www.microchip.com/support.

### DOCUMENT REVISION HISTORY

#### **Revision A (August 2013)**

• Initial Release of this Document.

NOTES:



# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD USER'S GUIDE

### **Chapter 1. Product Overview**

### 1.1 INTRODUCTION

The EMC1182 Temperature Sensor Evaluation Board provides an easily accessible platform to test the various features of the EMC1182. The System Management Bus (SMBus) communication is accomplished using an Universal Serial Bus (USB) bridge, providing a standard interface for the application code interface. The board is populated with a 3x3 DFN version of the EMC1182 device.

### 1.2 EMC1182 DEVICE FEATURES

The EMC1182 device is a two-channel SMBus temperature sensor featuring both pin-selectable and fixed SMBus address capability. The communications bus is also compatible with I<sup>2</sup>C communication protocol (see SMSC<sup>®</sup> application note AN 14.0 rev.1.1 - *"SMSC Dedicated Slave Devices in I<sup>2</sup>C Systems"* for details on the differences between the SMSC SMBus implementation and standard I<sup>2</sup>C/SMBus).

One externally connected temperature diode and one internal diode are available for temperature sensing. THERM and ALERT outputs have programmable temperature limits.

### 1.3 WHAT IS THE EMC1182 TEMPERATURE SENSOR EVALUATION BOARD?

All functions of the EMC1182 device can be tested and observed using the USB-based EMC1182 Temperature Sensor Evaluation Board. Figure 1-1 shows the block diagram of this board.



The evaluation system is comprised of the EMC1182 Temperature Sensor Evaluation Board and the SMSC Chip Manager application. The EMC1182 Temperature Sensor Evaluation Board has the following features:

- Headers for connecting an external diode or CPU/GPU
- Resistance Error Correction verification
- USB-to-SMBus bridge for power and communications
- · Capability to connect directly to an external SMBus master

The user can perform the following operations using the Chip Manager:

- Viewing and changing register values
- · Saving settings of all registers, allowing for quick configuration at a later time
- Graphing of any register

The evaluation board was designed for ease of use and experimentation purposes. Figure 1-2 shows the top silk screen of the EMC1182 Temperature Sensor Evaluation Board.



# 1.4 WHAT THE EMC1182 TEMPERATURE SENSOR EVALUATION BOARD KIT CONTAINS

This EMC1182 Temperature Sensor Evaluation Board kit includes:

- EMC1182 Temperature Sensor Evaluation Board (ADM00516)
- Supplied USB cable
- Important Information Sheet



# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD USER'S GUIDE

### **Chapter 2. Installation and Operation**

### 2.1 GETTING STARTED

### 2.1.1 System Requirements

To use the EMC1182 Temperature Sensor Evaluation Board, the following are required:

- A PC running the Microsoft<sup>®</sup> Windows<sup>®</sup> operating system
- A display resolution of 800x600 or larger, for viewing several windows simultaneously
- An available USB port

### 2.1.2 Installing the Evaluation Board

Follow the next steps to install the SMSC Chip Manager.

- Download the ChipMan.zip file from the board web page. Unzip the archive. The application's revision history and install/uninstall notes may be found in the readme.txt file.
- 2. To install the Chip Manager application and the device driver on the PC, run the Setup.exe.
- 3. Connect the supplied USB cable to an available USB port on the PC. Plug the mini-B end of the USB cable into the board connector P3. The +3.3V and the Bridge ACT LEDs should illuminate.
- 4. If the USB Bridge driver has not previously been installed on the selected USB port, the Driver Software Installation window pops up, prompting for the driver install (see Figure 2-1).

🧊 Driver Software Ins	tallation	
Installing device drive	er software	
SMSC USB Bridge	Searching Windows Update	
Obtaining device drive Skip obtaining driver s	er software from Windows Update might take a while. software from Windows Update	
	Driver Software Installation	×
	SMSC USB Bridge installed	
	SMSC USB Bridge	
		Close
	Device Driver Load and Complete	Close

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5. After the driver installation is complete, the initial setup screen for the Chip Manager application appears (see Figure 2-2). Click **Next** to start the installation.

SMSC Chip Manager Setup ver 4.1	6.4	×
	Welcome to the InstallShield Wizard for ChipMan	
	The InstallShield® Wizard will install ChipMan on your computer. To continue, click Next.	
	< Back Next > Cancel	

- FIGURE 2-2: InstallShield Wizard Startup Window.
- 6. Read and accept the licensing agreement, in order to complete the installation. To continue, click **Yes**.

SMSC Chip Manager Setup ver 4.16.4
License Agreement
Please read the following license agreement carefully.
Press the PAGE DOWN key to see the rest of the agreement. $\kappa_5$
SMSC SOFTWARE LICENSE AGREEMENT (OEM / IHV / ISV Distribution & Single User)
IMPORTANT - READ BEFORE COPYING, INSTALLING OR USING. Do not use or load this software and any associated materials (collectively, the "Software") until you have carefully read the following terms and conditions. By loading or using the Software, you agree to the terms of this Agreement. If you do not wish to so agree, do not install or use the Software.
Please Also Note: * If you are an Original Equipment Manufacturer (OEM), Independent Hardware Vendor (IHV), or
Do you accept all the terms of the preceding License Agreement? If you select No, Print the setup will close. To install ChipMan, you must accept this agreement.
InstallShield
<back no<="" th="" yes=""></back>
FIGURE 2-3: License Agreement Dialog.

 On the Choose Destination Location dialog, browse for the desired location, or click Next to install in the default location (see Figure 2-4). The application setup window appears, showing the installation progress (see Figure 2-5).

SMSC Chip Manager Setup ver 4.16.4	×
Choose Destination Location Select folder where setup will install files.	
Setup will install ChipMan in the following folder.	
To install to this folder, click Next. To install to a different folder, click Browse and select another folder.	
Destination Folder	
C:\Program Files (x86)\SMSC\ChipMan Browse	
InstallShield	_
<back next=""> Cancel</back>	
н <u>з</u>	

FIGURE 2-4:

Destination Path Dialog.

SMSC Chip Manager Setup ver 4.16.4	×
Setup Status	
ChipMan is configuring your new software installation.	
•	
InstallShield	Cancel

 After the setup is complete, the MSXML Parser used by the Chip Manager software is installed, as shown in Figure 2-6. Once the setup completes successfully, press Finish to exit the install.



FIGURE 2-6: MSXML Parser Install Window.

 Start the software by either going to Windows <u>Start button > All Programs ></u> <u>SMSC > SMSC Chip Manager</u> or by double-clicking the software icon (↔) on the desktop. The evaluation board software will initialize and the SMSC Chip Manager with the Quick Help screen appears (see Figure 2-7).

🔗 SMSC Chip Manager		<u>- 🗆 X</u>
File View Options Control Help		
学 🖬 🛊 💡		
	Quick Help:	
	The purpose of this utility is to allow the user to view and edit SMSC device registers in the Windows environment. To view a group of registers, select the appropriate group in the left pane. To edit the value of a register, double click the value in the "Last Value" column in the right upper pane. Type in the desired value. The register will be updated with the new value conce the cursor leaves the edit window. Read only registers are denoted by "R" in the "R/W" column and editing of these register values is disallowed. Some registers have bit field definitions. They are displayed in the lower right pane. If the register is not read only (i.e. read/write) the value of each field can be edited by double clicking on the field value in the "Last Value" column of this pane. Type in the desired value to update the bit(s) of the register. The field may also be changed by making a selection from the field's drop down list. If a drop down list is available for this field, a combo box style button will appear a the right othe "Translation" column. Clicking the button will allow you to select a setting for the bit field from a drop down list.	
	The current values of the registers can be saved to an external text file by using the Export feature. The saved text file can also be read back to the device by using the Import feature. Import only affects read/write registers.	
Dbl click value in Last Value column to edit		1.

FIGURE 2-7:

 If a message stating that no device has been selected appears, click Yes to select a device. Alternatively, go to the Chip Manager's main menu, select <u>Options > Select Device</u>. In either case, the Select SMSC Device window displays, as shown in Figure 2-8.

In the "SMSC Device" list, choose EMC1182. From the "Master Controller" drop-down list choose "SMBus USB-SMB-SPI Bridge". Click **OK** to complete the device selection.

SMSC Chip Manager	Select SMSC Device
No SMSC device has been selected Would you like to select a device?	Device Remote SMSC Device: EMC1182
Yes No	Configuration Address:
	SMBus Settings
	Slave Addresses: Block Registers Slave Address HWM 02:FF 98
	Select automatically
	Master Controller: SMSC USB-SMB-SPI Bridg  //O Controller Hub USB SMBus Bridge SMSC USB-SMB-SPI Bridge
	OK Cancel

FIGURE 2-8:

Select SMSC Device Window.

11. From the Chip Manager main menu, ensure that <u>Options > Auto refresh</u> <u>Registers</u> is checked. In the left panel, click the hardware monitor (HWM) to expand the content, then select any of the register groups, as shown in Figure 2-9. The USB Activity LED on the board starts blinking when any of the register groups are selected. The register values are automatically updated every second when the Auto Refresh option is on.

🚓 SMSC Chip Manager - SMSC Confidentia	ı							
File View Options Control Help								
🖻 🖬 👔 💡								
EMC1182	Register Name	Ac	dress	R/W	Last Val	Units	Abbreviation	Bus Type
EMC1182     HWM     O : Status     Y 1 : Configuration     Y 2 : Legacy Mode Temperatures     Y 3 : Extended Mode Temperatures     Y 4 : Device Info	Register Name         Internal Temp         External Diode Temp         Internal Temperature High Limit         Internal Themperature Low Limit         External ThERM Limit         External Temperature Low Limit         External THERM Limit         External THERM Limit         THERM Hysteresis         Bit Field Name	Act 000 01 06 06 20 07 06 15 21 8 15 21	dress,29 ,10 ,13 ,14 Last Vali	R/W R R R W R W R W R W R W R W R W R W	Last Val FF FF FF FF FF FF FF FF	Units Degrees(C) Degrees(C) Degrees(C) Degrees(C) Degrees(C) Degrees(C) Degrees(C) Degrees(C) Degrees(C)	Abbreviation TLAM TLD1 TALH TALL THAL T1LH T1LH T1LL TH1L TH1L THH	Bus Type SMBUS SMBUS SMBUS SMBUS SMBUS SMBUS SMBUS SMBUS
Dbl click value in Last Value column to edit	Block	HVVM / (	Group 2	: Lega	acy Mode Te	mperatures		

FIGURE 2-9: Chip Manager Register Groups.



# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD USER'S GUIDE

### **Chapter 3. Hardware Description**

### 3.1 INTRODUCTION

The EMC1182 Temperature Sensor Evaluation Board provides the means to demonstrate all of the EMC1182 features, and allows the registers to be viewed and modified. LEDs indicating status information and test points are included to enable system voltage monitoring, using a voltmeter or an oscilloscope.

#### 3.1.1 Power Source

The board requires only one universal serial bus (USB) connection to power the board. The USB-to-SMBus bridge regulates the +5V USB power to +3.3V used by the EMC1182 and other evaluation board circuitry.

### 3.2 USB-TO-SMBUS BRIDGE

The USB-to-SMBus bridge is based on an 8-bit microcontroller with integrated USB and SMBus interfaces, as well as internal flash and RAM. During the evaluation board manufacturing process, the firmware is loaded into the bridge that provides the interface between the USB and the SMBus. Power is sourced to the microcontroller from the USB interface for device power and communication.

### 3.2.1 Direct SMBus Connect Option

It is also possible to connect an external SMBus master to the EMC1182 Temperature Sensor Evaluation Board. A few jumper settings are required to drive the EMC1182 on the evaluation board, as explained in the following steps:

- Remove the jumpers on header JP10 and connect the SMBus master to the SDA, SCL and ALERT pins (3, 5 and 7, respectively), as well as an external supply for +3.3V (pin 1).
- Remove resistors R19, R20, R22 and R25, shown in Figure 3-1.
- The +3.3V can be supplied by the SMBus bridge by leaving the +3.3V jumper in place and retaining the USB connection.

#### 3.2.2 Supplemental 1.8V SMBus Pull-up

A 1.8V (nominal) linear regulator is placed on the board along with the jumpers to connect SDA and SCL to a 1.8V pull-up supply. Once the jumper resistors are disconnected, jumpers connecting J2-1 to J2-2 and J2-3 to J2-4 may be installed to activate the 1.8V pull-ups. This jumper is identified in Figure 3-1 by the blue circle.

### **EMC1182** Temperature Sensor Evaluation Board User's Guide



FIGURE 3-1: SMBus Jumper Resistors.

### 3.3 RESISTANCE ERROR CORRECTION (REC)

The external diode 1 (Q1) on the board has a series resistance adjustment on the DN line. Checking the Resistance Error Correction (REC) feature is accomplished by turning the resistor wheel R5. With the REC on, the temperature will not change as the wheel is turned. With REC off, a significant temperature error will occur.

### 3.4 TEST POINTS

The EMC1182 Temperature Sensor Evaluation Board includes test points for the following:

- ALERT output (TP1)
- THERM output (TP2)

### 3.5 LED INDICATORS

Table 3-1 details the LEDs status of the following signals:

LED No.	Signal	When LED is OFF When LED is ON		Color
LED1	ALERT	+3.3V power OFF	ALERT	red
LED3	+3.3V	+3.3V power OFF	+3.3V power ON	green
LED4	Bridge Activity	NO Activity on USB/SMBus Bridge	Activity on USB/SMBus Bridge	green
LED5	USB Activity	NO Activity on USB port	Activity on USB port	green

TABLE 3-1:LED STATUS INDICATORS

### 3.6 **REMOTE DIODES**

The evaluation board is populated with jumpers to connect to the on-board diode or an off-board diode (see Table 3-2).

To connect to an off-board CPU or GPU, remove both jumpers from header J1. Then connect Pin 1 to the 'remote+' terminal of the off-board diode and Pin 2 to the 'remote-' terminal of the off-board diode. Make sure a common ground exists between the off-board diode (GPU, etc.) and the evaluation board. Ensure that the off-board diode is properly biased. Consult the CPU manufacturer's data sheet for guidance on interfacing to the thermal diode. Refer to the EMC1182 Temperature Sensor Evaluation Board schematic in **Appendix A. "Schematic and Layouts"** for details on the evaluation board header connections.

TABLE 3-2: F	REMOTE DIODE	CONFIGURATIONS
--------------	--------------	----------------

Jumper	Configuration	Pin 1	Pin 2	Pin 3	Pin 4
J1	On-board diode (Q1)	short/DP		short/DN	
	General purpose remote diode	open	remote+/DP	open	remote-/DN
	CPU/GPU diode	good common ground			

### 3.7 OTHER SENSOR FEATURES

Other features, such as Conversion Rate, Dynamic Averaging and Digital Filtering, can be controlled with the EMC1182 registers. Refer to the device data sheet for details on the register description.

NOTES:



# EMC1182 TEMPERATURE SENSOR EVALUATION BOARD USER'S GUIDE

### **Chapter 4. Software Description**

### 4.1 CHIP MANAGER APPLICATION OVERVIEW

The Chip Manager application enables the user to display temperature readings, set temperature limits and read/write configuration register values. The Chip Manager initially displays a Quick Help screen (see Figure 2-7). For detailed information on application features and usage, select <u>Help > Contents</u> to display the HTML-based Help document, as shown in Figure 4-1.



FIGURE 4-1: Chip Manager Help Screen.

### 4.1.1 Real-Time Register Graphs

The Chip Manager software has the ability to plot register values in real-time, up to a 10 Hz continuous rate.

### 4.1.2 Selecting Registers to Plot

1. To plot a register, right-click the desired register name or value. Select the "Add Register(s) to Plot" from the context menu (see Figure 4-2), to add the register or value to the plot list.

🗢 SMSC Chip Manager - SMSC Confidential								
File View Options Control Help								
🚔 🖬 😰 💡								
	Register Name	Address	R/W	Last Val Units	Abbreviation Bus Type			
🗄 🗦 HWM	Internal Temp	00,29	R	EE Degrees(C)	TLAM SMBUS			
🚽 🌮 O : Status	External Diode Temp	01,10	R	Add Register(s) to Plot	NTLD1 SMBUS			
1 : Configuration	Internal Temperature High Limit	05	RW	FF Degrees(C)	TALH SMBUS			
2 : Legacy Mode Tempera	Internal THERM Limit	20	RW	FF Degrees(C)	THAL SMBUS			
3 : Extended Mode Tempe	External Temperature High Limit	07,13	RW	FF Degrees(C)	T1LH SMBUS			
	External Temperature Low Limit	08,14	RW	FF Degrees(C)	T1LL SMBUS			
	External THERM Limit	19	RW	FF Degrees(C)	TH1L SMBUS			
	THERM Hysteresis	21	RW	FF Degrees(C)	THH SMBUS			
			. [		<u> </u>			
	Bit Field Name	Bit(s) Last Va	alue   Tr	anslation				
UDI click value in Last value column to edit Block HWM / Group 2 : Legacy Mode Temperatures								

FIGURE 4-2: Adding Registers to Plot.

2. Once the desired register is added to be plotted, a graphic plot window will appear with a legend on top, as shown in Figure 4-3. The two windows can be rearranged independently.



### FIGURE 4-3: Register Plot Window.

3. To plot additional registers, go back to the Chip Manager main window and repeat Step 1.

### 4.1.3 Starting the Plots

All plots can be started simultaneously by selecting <u>Control > Plots > Start All Plots</u> from the menu, in the main application window. Multiple plots will be in sync if they are started simultaneously.

Individual plots may be paused at any time by clicking <u>Control > Pause</u> in the plot window. This will not cause loss of captured data on the other plot windows.

For a better view on the plot, select a different "Time per division" value in the drop-down menu at the bottom of the plotting window. This scale change affects both the real-time mode and the playback mode, while the rate at which data is recorded is unaffected.

#### 4.1.4 Sampling a Plot

Figure 4-4 is an example of temperature history. Internal Temperature, External Diode 1 Temperature and External Diode 1 High Limit are selected for plotting. The results after the plot starting are that the External Diode Temperature High Limit is reduced, the External diode 1 starts at room temperature and is then heated by simply placing a finger on the external diode Q1.



FIGURE 4-4: EMC1182 Temperature History Graph.